


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	ADG/20/12438	
1.3 Title of PCI	Wire bonding layout update	
1.4 Product Category	SiC MOSFET	
1.5 Issue date	2020-11-16	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Maurizio Maria FERRARA
2.1.2 Marketing Manager	Michele MACAUDA
2.1.3 Quality Manager	Vincenzo MILITANO

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Methods	Process adjustment within specification limits when no reliability or quality risk has been highlighted by the risk assessment.	STS Shenzhen

4. Description of change

	Old	New
4.1 Description	2 source wires	4 source wires
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no impact	

5. Reason / motivation for change

5.1 Motivation	Quality Improvement
5.2 Customer Benefit	QUALITY IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	NA
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7. Timing / schedule

7.1 Date of qualification results	2020-11-05
7.2 Intended start of delivery	2020-12-05
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

12438 Public product.pdf
12438 PCI - SCTH90N65G2V-7 Wire bonding layout update.doc

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	SCTH90N65G2V-7	

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Public Products List

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PCI Title : Wire bonding layout update

PCI Reference : ADG/20/12438

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

SCTH90N65G2V-7		
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